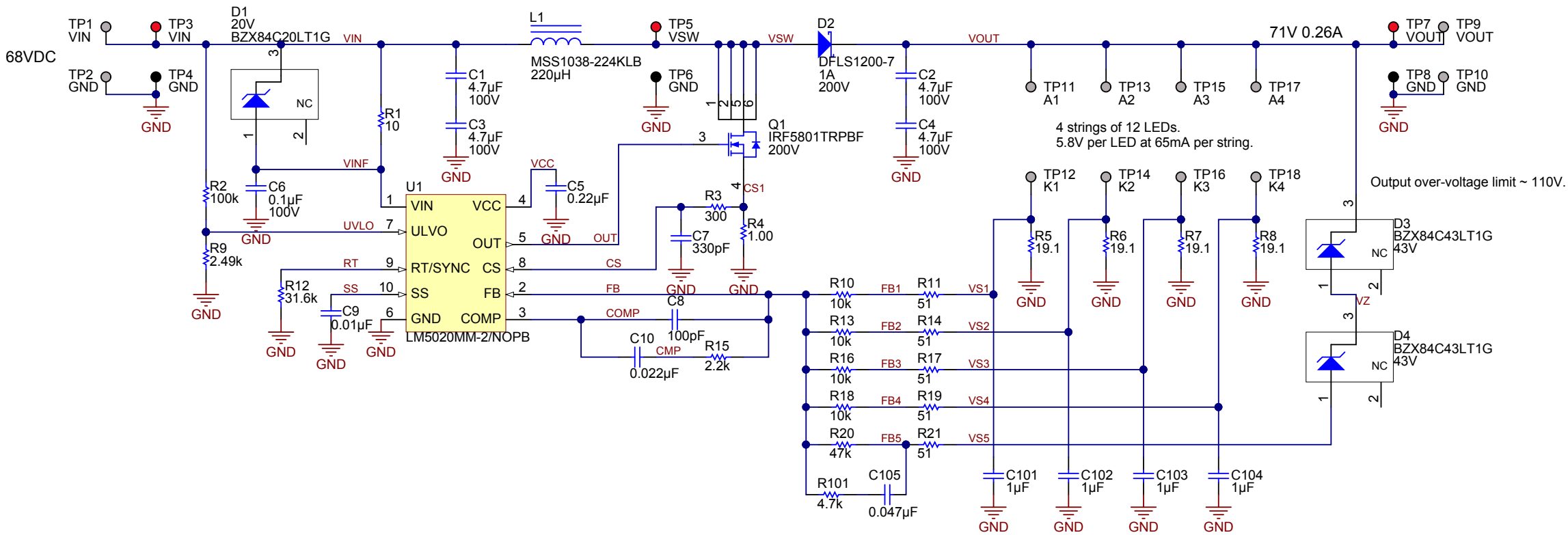


- Notes:
1. Built on Rev A printed circuit board.
 2. Reference designators greater than 100 are additional components that do not appear on the Rev A printed circuit board.
 3. For constant voltage load testing set load to 65V and use 100 ohms series resistance per string to model the LED forward voltage and dynamic resistance.
 4. For frequency response testing use 470uF 80V aluminum electrolytic capacitor across the constant voltage load.
 5. For higher input voltage option remove R1 and adjust D1 for 100V abs max at the LM5020.

Revision History	
Revision	Notes
A	Initial design
B	Add C101-104 for stability
C	Change frequency compensation



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